

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	9525	((257/715,712,713,714,717,706) or (361/704,705,707,708,717,718)). CCLS.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	OFF	2005/08/30 16:18
S2	206665	nano\$11 or (carbon adj nanotube)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:19
S3	125	S1 and S2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:19
S4	57517	S2 and thermal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:42
S5	2866	S4 and (heat adj sink)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:43
S6	1036	S5 and adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:43
S7	991	S6 and (@ad<"20031231" or @rlad<"20031231")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:44
S8	545	S6 and (@ad<"20031231" or @rlad<"20031231")	USPAT	OR	ON	2005/08/30 16:44
S9	96	(air adj jet adj impingement)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 10:35
S10	16	active adj (coolin or heating or thermal) adj device	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 10:37

S11	172	active adj (cooling or heating or thermal) adj device	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 10:37
S12	6	dielectric adj liquid adj device	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 11:13
S13	1	S11 and (dielectric adj liquid)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 11:14
S14	1	(active adj cooling adj device) with (dielectric adj liquid)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 11:15
S15	30469	(dna or (deoxyribonucleic adj acid)) and nano\$11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:42
S16	40	S15 and hea	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:42
S17	15071	S15 and heat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:43
S18	9927	S17 and @ad<"20031231" and @rlad<"20031231"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:43
S19	3672	S18 and thermal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:44
S20	185	S19 and ((heat adj sink) or (heat adj spreader) or (thermal adj management adj device))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:56

S21	305	S15 and ((heat adj sink) or (heat adj spreader) or (thermal adj management adj device))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:57
S22	85235	((heat adj sink) or (heat adj spreader) or (thermal adj management adj device))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:57
S23	707	S22 and dna	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 10:57
S24	76842	wiring adj board	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:45
S25	726	S24 and (memory adj device)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 14:21
S26	282	S25 and heat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 14:21
S27	264	S26 and (@ad<"20031231" or @rlad<"20031231")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 14:22
S28	157	(active adj cooling adj device)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 15:48
S29	19	S28 and nano\$11	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 16:32
S30	1155	S24 and ((memory adj chip) or (memory adj device) or (memory adj ic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 16:34

S31	110	S30 and ((heat adj sink) or (heat adj spreader) or (thermal adj management adj device) or (cooling adj device))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/06 16:35
S34	76842	wiring adj board	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:45
S35	8233	S34 and (printed adj circuit adj board)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:46
S36	2786	S35 and thermal	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:46
S37	2094	S36 and heat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:46
S38	728	S37 and cooling	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:59
S39	714	S38 and (@ad<"20031231" or @riad<"20031231")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/07 11:59